## BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS015015004-SF-4C

Description: 15.00 x 15.00 x 4.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin
Heat Sink Attachment: superGRIP
Equivalent Part Number: N/A

\*Image above is for illustration purpose only.

## **Features & Benefits**

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

## **Thermal Performance**

| AIR VELOCITY       |               | @200 LFM<br>1.0 M/S | @300 LFM<br>1.5 M/S | @400 LFM<br>2.0 M/S | @500 LFM<br>2.5 M/S | @600 LFM<br>3.0 M/S | @700 LFM<br>3.5 M/S | @800 LFM<br>4.0 M/S |
|--------------------|---------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| THERMAL RESISTANCE | Unducted Flow | 47.08 °C/W          | 40.2 °C/W           | 35.9 °C/W           | 32.8 °C/W           | 30.4 °C/W           | 28.5 °C/W           | 27 °C/W             |
|                    | Ducted Flow   | 27.5                | 23.1                | 20.4                | 18.5                | 17                  | 15.9                | 15                  |

## **Product Detail**





